

UTC UNISONIC TECHNOLOGIES CO., LTD

6N70Z

Preliminary

6.0A, 700V N-CHANNEL POWER MOSFET

DESCRIPTION

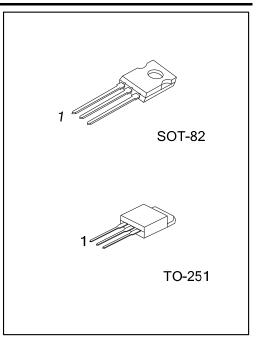
The UTC 6N70Z is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, high switching speed, low gate charge and low input capacitance.

The UTC 6N70Z is universally applied in high efficiency switch mode power supply.

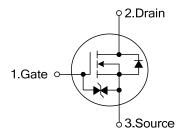
FEATURES

* $R_{DS(ON)}$ =1.9 Ω @ V_{GS} =10V, I_D =3A

* High switching speed



SYMBOL



ORDERING INFORMATION

Ordering Number		Deekere	Pin Assignment			Dealing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6N70ZL-T82-T	6N70ZG-T82-T SOT-82 G D		S	Tube			
6N70ZL-TM3-T	6N70ZG-TM3-T	TO-251	G	D	S	Tube	
Nata: Din Assignment: C: Cata D: Droin S: Source							

Note: Pin Assignment: G: Gate D: Drain S: Source

6N70Z <u>L-T82</u> -T	— (1)Packing Type — (2)Package Type — (3)Lead Free	(1) T: Tube (2) T82: SOT-82, TM3: TO-251 (3) L: Lead Free, G: Halogen Free				
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ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

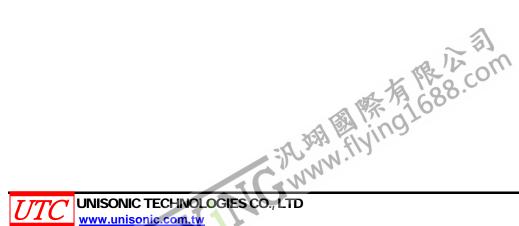
PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage (Note 2)		V _{GSS}	±20	V
	T _c =25	°C	6	А
Drain Current	Continuous $T_c=10$	lo°C	3.8	А
	Pulsed	I _{DM}	24	А
Avalanche Current (Note 2)		I _{AR}	6	А
Avalanche Energy	Single Pulsed (Note	e 3) E _{AS}	300	mJ
	Repetitive (Note 2)	E _{AR}	13	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.5	V/ns
Davida Dia sia stian	SOT-8	32	75	W
Power Dissipation	TO-25	51	55	W
Linear Derarting Factor		32 P _D	0.60	W/°C
		51	0.44	W/°C
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 30mH, I_{AS} = 6A, V_{DD} = 50V, R_G = 27 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 6A$, di/dt $\le 140A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
lunction to Ambient	SOT-82	0	62.5	°C/W
Junction to Ambient	TO-251	θ_{JA}	110	°C/W
lunation to Case	SOT-82	0	1.67	°C/W
Junction to Case	TO-251	θ _{Jc}	2.27	°C/W



■ ELECTRICAL CHARACTERISTICS (T_c=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μΑ, V _{GS} =0V	700			V
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_{J}$	I _D =250μΑ		0.79		V/°C
Drain-Source Leakage Current		I _{DSS}	V _{DS} =700V			25	μA
			V _{DS} =560V, T _C =125°C			250	μA
Cata Cauras Laskaga Current	Forward	- I _{GSS}	V _{GS} =+20V, V _{DS} =0V			5	μA
Gate-Source Leakage Current	Reverse		V _{GS} =-20V, V _{DS} =0V			-5	μA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA, V _{DS} =5V	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =3A (Note 1)		1.65	1.9	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}			900	1200	pF
Output Capacitance		C _{oss}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz (Note 1, 2)		90	115	pF
Reverse Transfer Capacitance		C _{RSS}	1-1.000112 (100te 1, 2)		18	55	pF
SWITCHING PARAMETERS							
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =30V, I _D =0.5A, R _G =25Ω		40	70	ns
Rise Time		t _R			65	90	ns
Turn-OFF Delay Time		t _{D(OFF)}	V _{GS} =0~10V		140	165	ns
Fall-Time		t⊧			60	85	ns
Total Gate Charge		Q_{G}			26	30	nC
Gate to Source Charge		Q_{GS}	V _{DD} =50V, I _G =100µA, I _D =1.3A (Note 1, 2)		6.9		nC
Gate to Drain Charge		Q_{GD}	$I_D = 1.3A$ (Note 1, 2)		6.4		nC
SOURCE- DRAIN DIODE RATII	NGS AND CH	HARACTERIS	TICS				
Maximum Body-Diode Continuous Current		ls	Internel reverse an diade in			6	Α
Maximum Body-Diode Pulsed Current		I _{SM}	Integral reverse pn-diode in the MOSFET			24	٨
(Note 3)						24	A
Drain-Source Diode Forward Voltage		V _{SD}	I _S =6A, V _{GS} =0V, T _J = 25°C			1.4	v
(Note 2)			$V_{GS} = 0V, V_{J} = 25 C$			1.4	v
Body Diode Reverse Recovery Time		trr	I _F =6A, dI _F /dt=100A/µs,		440		ns
Body Diode Reverse Recovery Charge		Q _{RR}	$T_J = 25^{\circ}C$		4.05		μC

Notes: 1. Pulse Test: Pulse width \leq 250µs, Duty cycle \leq 2%

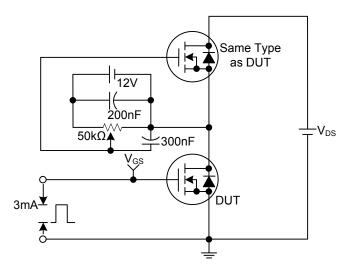
2. Essentially independent of operating temperature

3. Repetitive Rating: Pulse width limited by maximum junction temperature

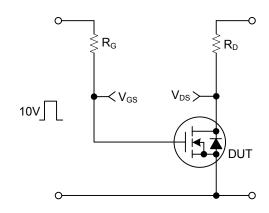
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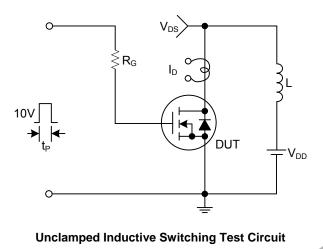
TEST CIRCUITS AND WAVEFORMS

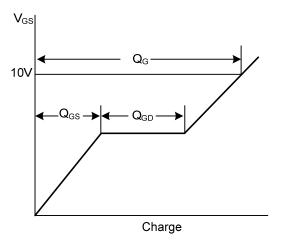


Gate Charge Test Circuit

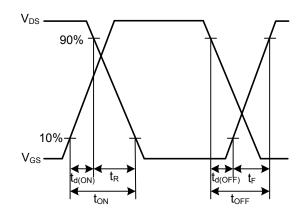


Resistive Switching Test Circuit

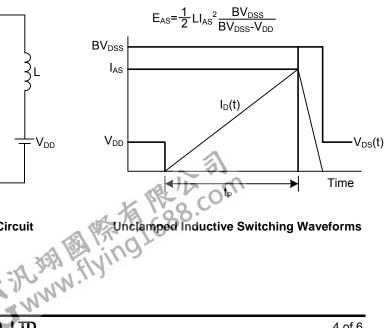


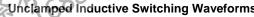






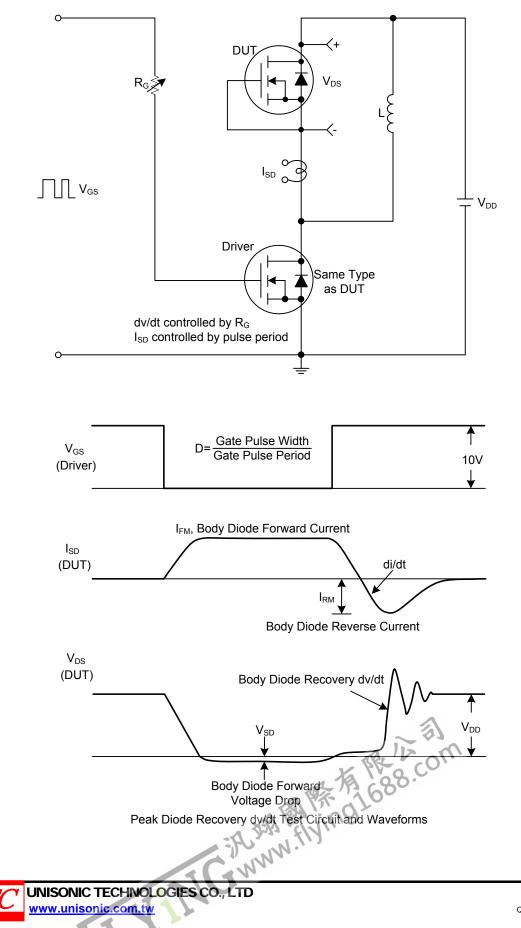
Resistive Switching Waveforms





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■ TEST CIRCUITS AND WAVEFORMS(Cont.)



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